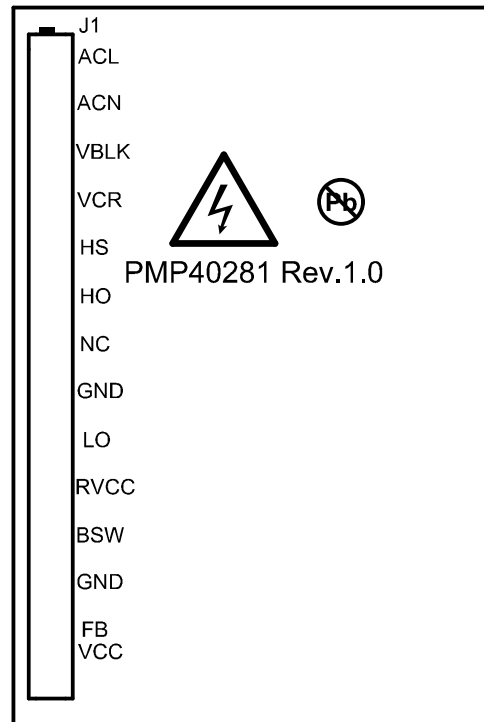
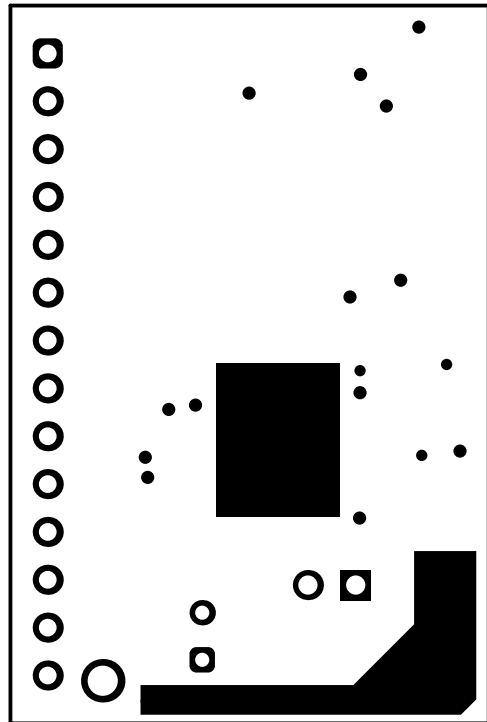


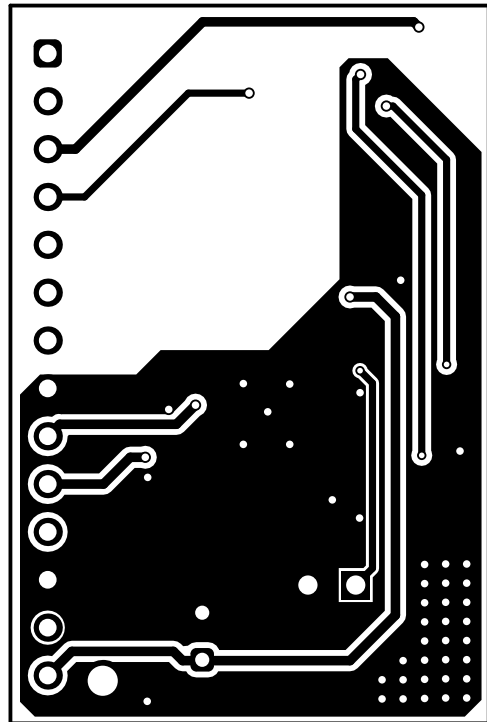
ZZ1
ZZ2
ZZ3
ZZ4



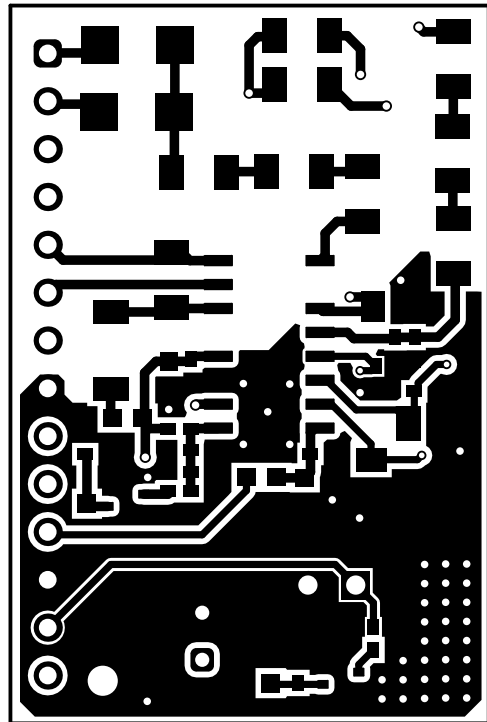
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP40281		
PLOT NAME = Top Overlay	GENERATED : 8/1/2017	7:14:58 PM	TEXAS INSTRUMENTS



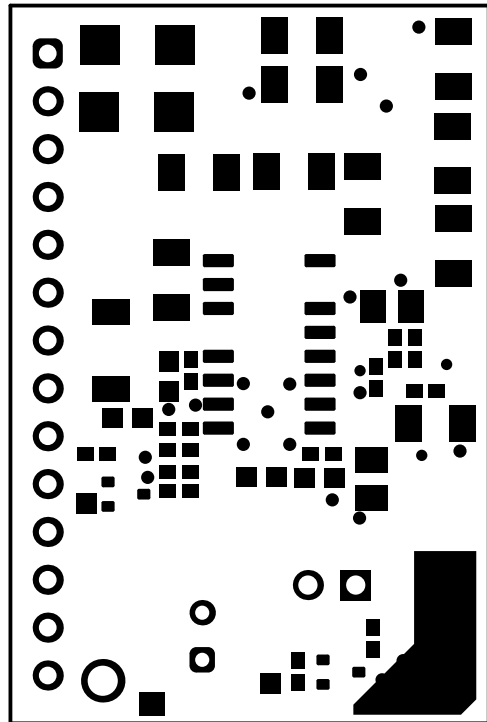
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP40281		
PLOT NAME = Top Solder Mask	GENERATED : 8/1/2017 7:14:59 PM	TEXAS INSTRUMENTS	



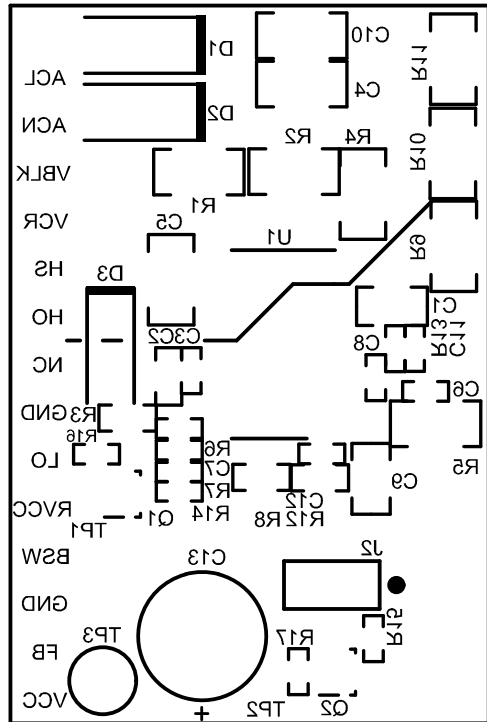
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP40281		
PLOT NAME = Top Layer	GENERATED : 8/1/2017	7:15:00 PM	TEXAS INSTRUMENTS



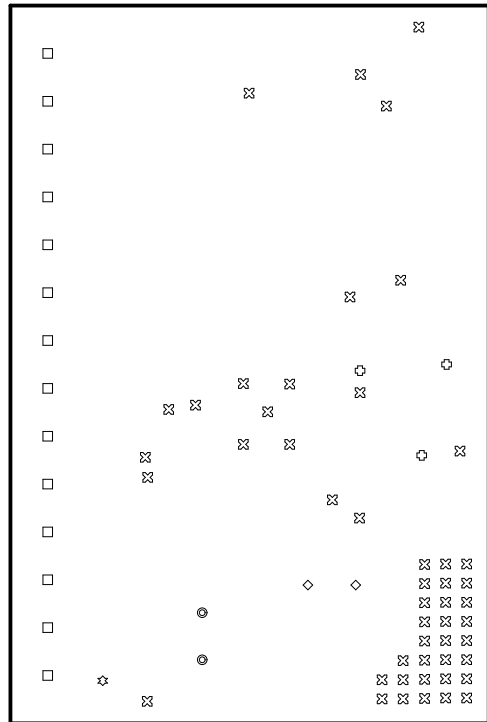
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP40281		
PLOT NAME = Bottom Layer	GENERATED : 8/1/2017	7:15:01 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP40281		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/1/2017 7:15:02 PM	TEXAS INSTRUMENTS	

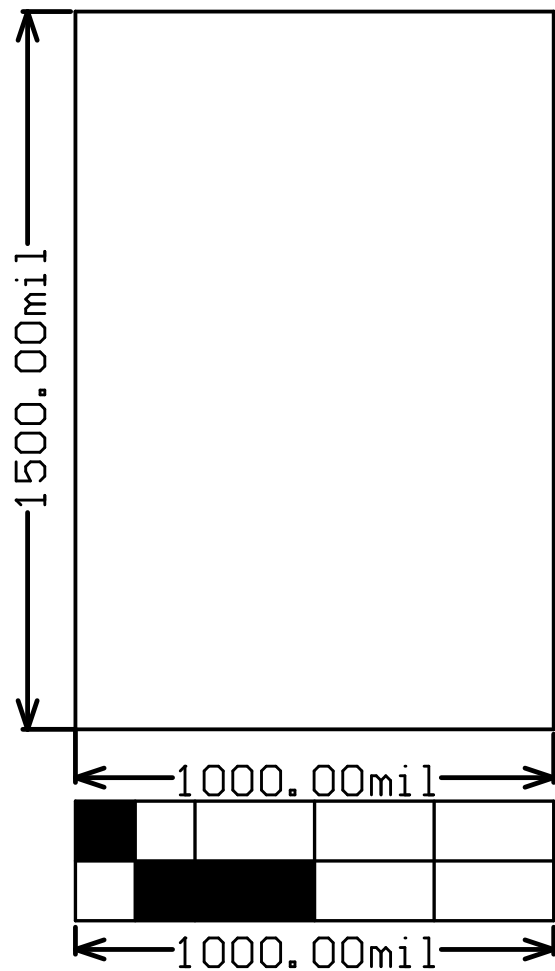


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP40281		
PLOT NAME = Bottom Overlay	GENERATED : 8/1/2017	7:15:03 PM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊕	3	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	+/-2.00mil
⊗	49	15.75mil (0.400mm)	PTH	Round	Top Layer - Bottom Layer	
●	2	29.53mil (0.750mm)	PTH	Round	Top Layer - Bottom Layer	
□	14	37.00mil (0.940mm)	PTH	Round	Top Layer - Bottom Layer	
◇	2	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	
☆	1	63.00mil (1.600mm)	PTH	Round	Top Layer - Bottom Layer	
	71 Total					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP40281		
PLOT NAME = Drill Drawing	GENERATED : 8/1/2017	7:15:04 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40281	REV: 1.0	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP40281		
PLOT NAME = Board Dimensions	GENERATED : 8/1/2017	7:15:05 PM	TEXAS INSTRUMENTS

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